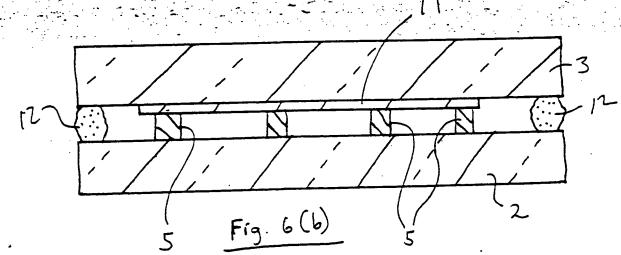


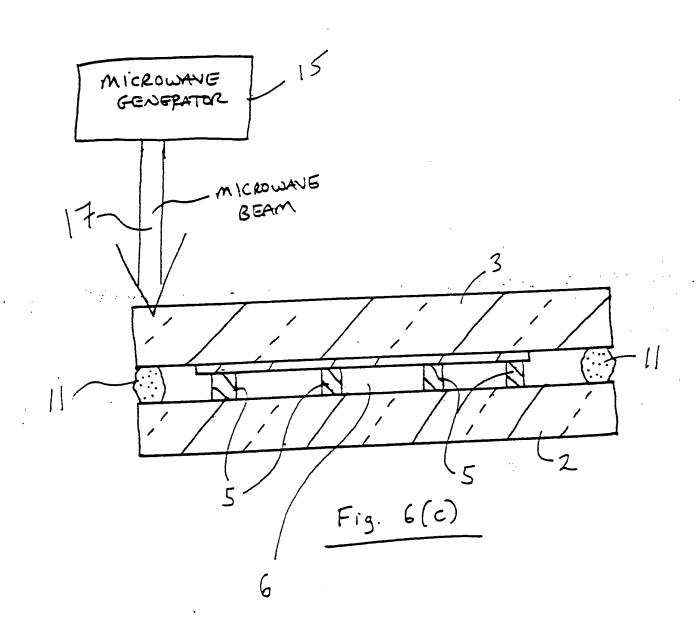
Fig. 60

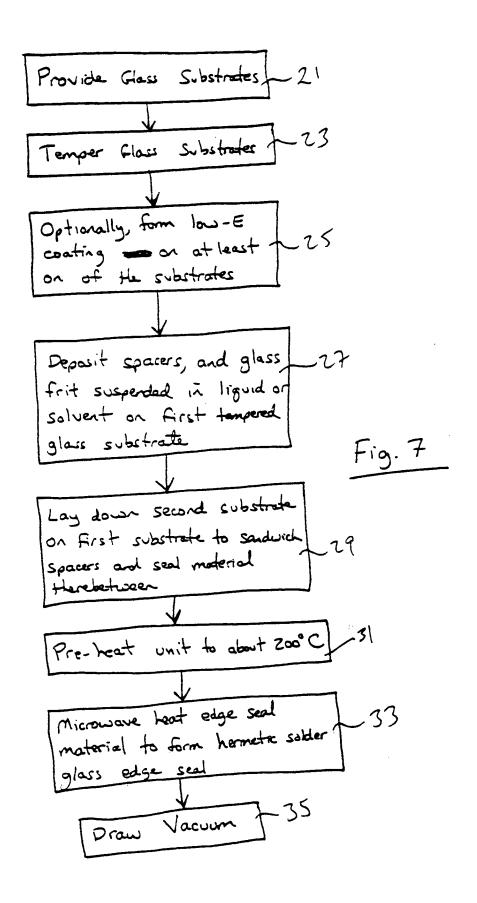


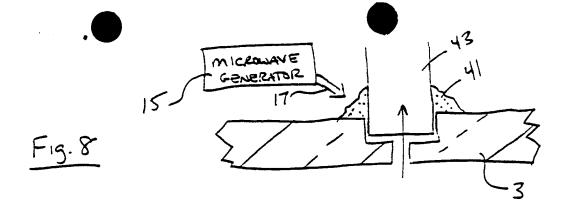
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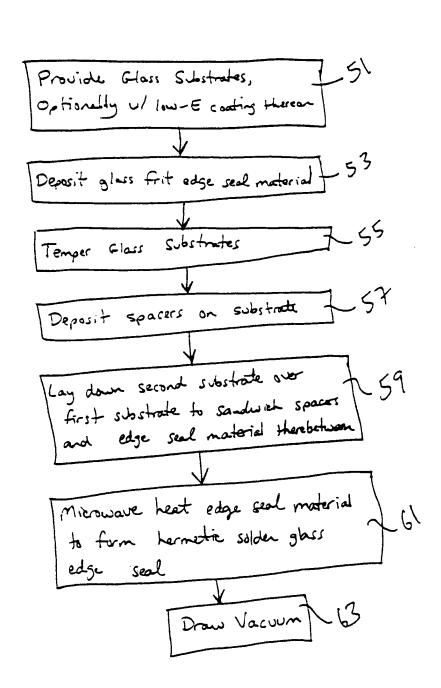
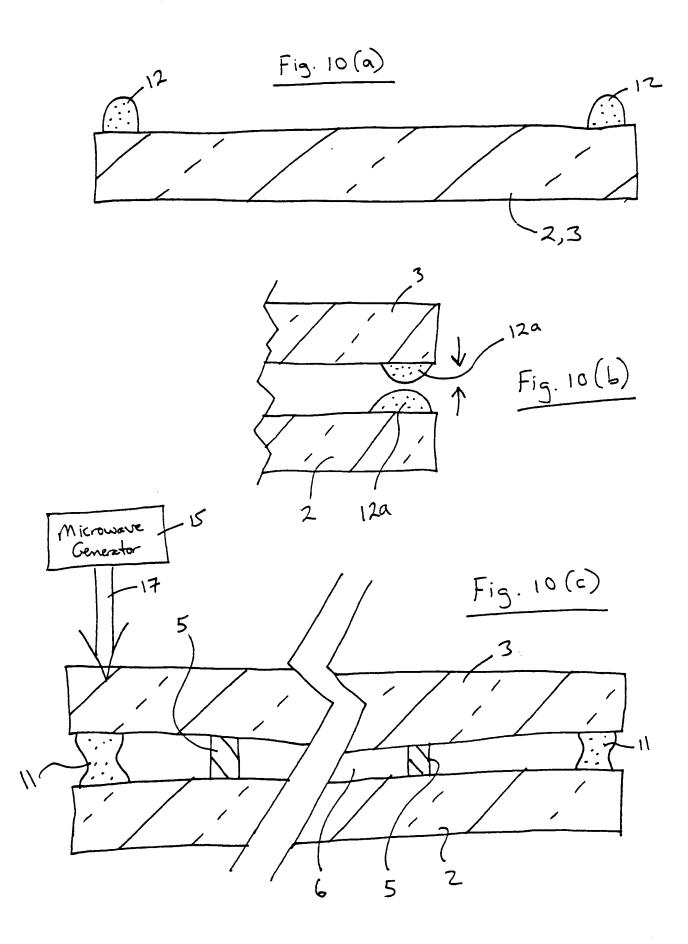


Fig. 9



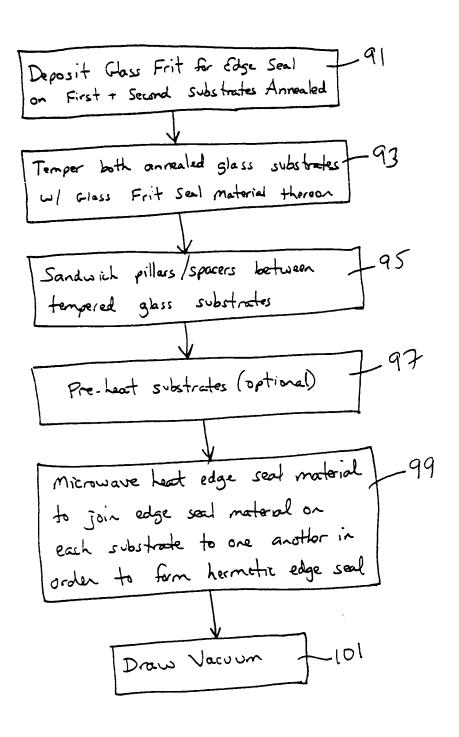


Fig. 11

201 Provide glass substrates (optionally, w/ low-E coating) Deposit glass frit (i.e., first glass frit) on one or both substrates for edge seal base Substrates Temper Deposit additional glass frit (i.e., second glass frit) on substrate(s) over first glass frit material, for edge seal Deposit spacers on substrate Sandwich spacers between substrates Preheat (optional) Microwave heat at least second glass frit to form hermetic edge seel Draw Vacuum

Fig. 12

